6ES7677-2DB42-0GB0



Data sheet



SIMATIC ET 200SP Open Controller, CPU 1515SP PC2, 8 GB RAM, 128 GB CFast with Windows 10 IoT Enterprise 64-bit and S7-1500 Software Controller CPU 1505SP pre-installed, Interfaces: 1x Slot CFast, 1x slot SD/MMC, 1x connection for ET 200SP bus Adapter PROFINET, 1x 10/100/1000 Mbit/s Ethernet, 2x USB 3.0, 2x USB 2.0, 1x display port, Documentation on CFast Restore image on CFast

General information	
Product type designation	CPU 1515SP PC2
HW functional status	from FS04
Firmware version	V20.8
Engineering with	
STEP 7 TIA Portal configurable/integrated from version	V16
Installed software	
 Visualization 	No
 Control 	S7-1500 Software Controller CPU 1505SP
Configuration control	
via dataset	Yes
Control elements	
Mode selector switch	1
Supply voltage	
Type of supply voltage	24 V DC
permissible range, lower limit (DC)	19.2 V
permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Mains buffering	
 Mains/voltage failure stored energy time 	5 ms
Input current	
Current consumption (rated value)	1.8 A; Full processor load, incl. ET 200SP modules and using USB
Current consumption (in no-load operation), typ.	0.5 A
Current consumption, max.	2.9 A
l²t	0.426 A ² ·s; with starting current inrush
Power	
Active power input, max.	43 W; incl. ET 200SP modules and using USB
Infeed power to the backplane bus	8.75 W
Power loss	
Power loss, typ.	16 W
Processor	
Processor type	Intel Atom E3940, 1.6 GHz, 4 cores
Memory	
Type of memory	DDR3L
Main memory	8 GB RAM
CFast memory card	Yes; 128 GB flash memory

SIMATIC memory card required	No
	INO
Work memory	1 Mbyto
• integrated (for program)	1 Mbyte
• integrated (for data)	5 Mbyte
 integrated (for CPU function library of CPU Runtime) 	20 Mbyte
Load memory	
• integrated (on PC mass storage)	320 Mbyte
Backup	020 Mbyte
• with UPS	Yes; all memory areas declared retentive
with or 3 with non-volatile memory	Yes
·	165
CPU processing times	
for bit operations, typ.	10 ns
for word operations, typ.	12 ns
for fixed point arithmetic, typ.	16 ns
for floating point arithmetic, typ.	64 ns
CPU-blocks	
Number of elements (total)	6 000; In addition to blocks such as DBs, FBs and FCs, UDTs, global constants, etc. are also regarded as elements
DB	
Number, max.	5 999; Number range: 1 to 65535
• Size, max.	5 Mbyte
FB	
Number, max.	5 998; Number range: 1 to 65535
• Size, max.	1 024 kbyte
FC	
Number, max.	5 999; Number range: 1 to 65535
• Size, max.	1 024 kbyte
OB	
Size, max.	1 024 kbyte
Number of free cycle OBs	100
Number of time alarm OBs	20
 Number of delay alarm OBs 	20
Number of cyclic interrupt OBs	20
Number of process alarm OBs	50
Number of DPV1 alarm OBs	3
Number of isochronous mode OBs	1
Number of technology synchronous alarm OBs	2
Number of startup OBs	100
Number of synchronous error OBs Number of synchronous error OBs	4
Number of synchronous error OBs Number of diagraphic clare OBs	2
Number of diagnostic alarm OBs Necting don'th	1
Nesting depth	24
per priority class	24
Counters, timers and their retentivity	
S7 counter	
Number	2 048
Retentivity	
— adjustable	Yes
IEC counter	
Number	Any (only limited by the main memory)
Retentivity	
— adjustable	Yes
S7 times	
Number	2 048
Retentivity	
— adjustable	Yes
IEC timer	

Number	Any (only limited by the main memory)
Retentivity	, , ,
— adjustable	Yes
Data areas and their retentivity	
Retentive data area (incl. timers, counters, flags), max.	410 kbyte; For storage in NVRAM; for storage in mass storage 5 242 020 bytes
Flag	
• Size, max.	16 kbyte
 Number of clock memories 	8; 8 clock memory bit, grouped into one clock memory byte
Data blocks	
Retentivity adjustable	Yes
Retentivity preset	No
Local data	
 per priority class, max. 	64 kbyte; max. 16 KB per block
Address area	
Number of IO modules	8 192
I/O address area	
Inputs	32 kbyte; All inputs are in the process image
Outputs	32 kbyte; All outputs are in the process image
Subprocess images	
Number of subprocess images, max.	32
Hardware configuration	
Integrated power supply	Yes
Number of distributed IO systems	20
Number of DP masters	
• Via CM	1
Number of IO Controllers	
via PC interfaces	1
Rack	
Modules per rack, max.	64; CPU 1515SP PC + 64 modules + server module
 Quantity of operable ET 200SP modules, max. 	64
 Quantity of operable ET 200AL modules, max. 	16
 Number of lines, max. 	1
PtP CM	
Number of PtP CMs	the number of connectable PtP CMs is only limited by the number of available slots
Time of day	
Clock	
• Type	Hardware clock
 Hardware clock (real-time) 	Yes; Resolution: 1 s
Backup time	6 wk; At 40 °C ambient temperature, typically
Deviation per day, max.	10 s; Typ.: 2 s
Clock synchronization	
supported	Yes
• to DP, master	Yes
 on Ethernet via NTP 	Yes
on Windows clock, slave	Yes
Interfaces	
Number of industrial Ethernet interfaces	2
Number of PROFINET interfaces	1
Number of PROFIBUS interfaces	1
Number of RS 485 interfaces	1; Via CM DP module
Number of USB interfaces	4; 2x USB 2.0, 2x USB 3.0 on front side
Number of SD card slots	1
Video interfaces	
Graphics interface	1x DisplayPort
1. Interface	
Interface type	PROFINET

automatic detection of transmission rate	Yes
Autonegotiation	Yes
Autocrossing	Yes
Number of connections	88
Interface types	
RJ 45 (Ethernet)	Yes; Via BusAdapter BA 2x RJ45
— Transmission rate, max.	100 Mbit/s
Industrial Ethernet status LED	Yes
Number of ports	2
• integrated switch	Yes
BusAdapter (PROFINET)	Yes; Compatible BusAdapter: BA 2x RJ45, BA 2x FC, BA 2x SCRJ
Bushuapter (FNOI INCT)	(from FS03, V2.2), BA SCRJ / RJ45 (from FS03, V3.1), BA SCRJ / FC (from FS03, V3.1), BA 2x LC (from FS03, V3.3), BA LC / RJ45 (from FS03, V3.3), BA LC / FC (from FS03, V3.3)
Protocols	
PROFINET IO Controller	Yes
PROFINET IO Device	Yes
SIMATIC communication	Yes
Open IE communication	Yes
Web server	Yes
PROFINET IO Controller	
Services	
— Isochronous mode	Yes
— shortest clock pulse	500 μs
— IRT	Yes
— PROFlenergy	Yes
63	
— Prioritized startup	Yes; max. 32 PROFINET devices; if you want to use the "Prioritized startup" functionality in STEP 7 for the PROFINET interface of the CPU the CPU and the device must be separated by means of a switch (e.g. SCALANCE X205)
 Number of connectable IO Devices, max. 	128
 Of which IO devices with IRT, max. 	64
— of which in line, max.	64
 Number of connectable IO Devices for RT, max. 	128
— of which in line, max.	128
 Number of IO Devices that can be simultaneously activated/deactivated, max. 	8
 IO Devices changing during operation (partner ports), supported 	Yes
 Number of IO Devices per tool, max. 	8
— Updating times	The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data
Update time for IRT	
— for send cycle of 500 μs	500 μs to 8 ms
— for send cycle of 1 ms	1 ms to 16 ms
— for send cycle of 2 ms	2 ms to 32 ms
— for send cycle of 4 ms	4 ms to 64 ms
With IRT and parameterization of "odd" send	Update time = set "odd" send clock (any multiple of 125 μs: 375 μs, 629
cycles	μs 3 875 μs)
Undete time for DT	
Update time for RT	F00 to 050
— for send cycle of 500 μs	500 μs to 256 ms
— for send cycle of 500 μs— for send cycle of 1 ms	1 ms to 512 ms
— for send cycle of 500 μs— for send cycle of 1 ms— for send cycle of 2 ms	1 ms to 512 ms 2 ms to 512 ms
 for send cycle of 500 μs for send cycle of 1 ms for send cycle of 2 ms for send cycle of 4 ms 	1 ms to 512 ms
— for send cycle of 500 μs— for send cycle of 1 ms— for send cycle of 2 ms	1 ms to 512 ms 2 ms to 512 ms
 for send cycle of 500 μs for send cycle of 1 ms for send cycle of 2 ms for send cycle of 4 ms 	1 ms to 512 ms 2 ms to 512 ms
 for send cycle of 500 μs for send cycle of 1 ms for send cycle of 2 ms for send cycle of 4 ms Address area	1 ms to 512 ms 2 ms to 512 ms 4 ms to 512 ms

lacebranaua mada	No
— Isochronous mode	No source
— shortest clock pulse	500 μs
— IRT	Yes
— PROFlenergy	Yes
— Prioritized startup	Yes
— Shared device	Yes
 Number of IO Controllers with shared device, max. 	4
	Yes
Asset management record 2. Interface	Tes
	14 4 150 414 6
Interface type	Integrated Ethernet interface
automatic detection of transmission rate	Yes
Autonegotiation	Yes
Autocrossing	Yes
Interface types	
• RJ 45 (Ethernet)	Yes; Integrated
Transmission rate, max.	1 000 Mbit/s
 Industrial Ethernet status LED 	No
Number of ports	1
3. Interface	
Interface type	PROFIBUS with CM DP
Number of connections via this interface	44
Interface types	
• RS 485	Yes
Protocols	
PROFIBUS DP master	Yes
PROFIBUS DP slave	Yes
SIMATIC communication	Yes
PROFIBUS DP master	103
Number of DP slaves, max.	125
Services	120
	No
— Equidistance	No No
— Isochronous mode	No
Address area	Olibuda
— Inputs, max.	8 kbyte
— Outputs, max.	8 kbyte
Interface types	
RS 485	
Transmission rate, max.	12 Mbit/s
Protocols	
Number of connections	
Number of connections, max.	88
 Number of connections reserved for ES/HMI/web 	10
 Number of S7 routing paths 	16
Redundancy mode	
Media redundancy	
— MRP	Yes
— MRPD	Yes
Switchover time on line break, typ.	200 ms
Number of stations in the ring, max.	50
SIMATIC communication	
PG/OP communication	Yes
• S7 routing	Yes
S7 routingS7 communication, as server	Yes
S7 communication, as server S7 communication, as client	Yes
User data per job, max. Onen IF communication.	64 kbyte; BSEND/BRCV: 64 KB; PUT/GET: 960 bytes
Open IE communication	V
• TCP/IP	Yes

-	****
— Data length, max.	64 kbyte
• ISO-on-TCP (RFC1006)	Yes
— Data length, max.	64 kbyte
• UDP	Yes
— Data length, max.	2 048 byte
• SNMP	Yes
• DCP	Yes
• LLDP	Yes
Web server	
• HTTP	Yes; Via Windows and PROFINET interface
• HTTPS	Yes; Via Windows and PROFINET interface
OPC UA	
 Runtime license required 	Yes; "Small" license required
OPC UA Client	Yes; From SW CPU 1505SP V2.6
OPC UA Server	Yes; Data access (read, write, subscribe), runtime license required
 Application authentication 	Yes; Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
 Security policies 	Yes; Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
— User authentication	Yes; "anonymous" or by user name & password
Further protocols	
• MODBUS	Yes; MODBUS TCP
S7 message functions	
Number of login stations for message functions, max.	32
Program alarms	Yes
Number of configurable program messages, max.	10 000
Number of simultaneously active program alarms	1 000
Number of program alarms	1 000
 Number of alarms for system diagnostics 	200
Number of alarms for motion technology objects	160
Test commissioning functions	
Joint commission (Team Engineering)	Yes; Parallel online access possible for up to 8 engineering systems
Status block	Yes; up to 8 simultaneously
Single step	No
Number of breakpoints	8
Status/control	
Status/control variable	Yes
Variables	Inputs, outputs, memory bits, DB, times, counters
Number of variables, max.	inputs, outputs, memory bits, bb, times, counters
of which status variables, max.	200
of which status variables, max. — of which control variables, max.	200
— or which control variables, max.	200
• Forcing	Yes
Forcing Forcing, variables	Inputs, outputs
Number of variables, max.	200
Number of variables, max. Diagnostic buffer	200
	Voc
Plumber of entries, may	Yes 1 000
Number of entries, max. of which powerful proof.	
— of which powerfail-proof	300
Traces	A
Number of configurable Traces Memory size per trace, may	4 E42 khyta
Memory size per trace, max.	512 kbyte
Interrupts/diagnostics/status information	
Diagnostics indication LED	
RUN/STOP LED	Yes
• ERROR LED	Yes
MAINT LED	Yes
Supported technology objects	1.00

Mation Control	Vaa
Motion Control • Number of available Motion Control resources for	Yes
technology objects	2 400
Required Motion Control resources	
per speed-controlled axis	40; per axis
per positioning axis	80; per axis
per synchronous axis	160; per axis
— per external encoder	80; per external encoder
— per output cam	20; per cam
— per cam track	160; per cam track
— per probe	40; per probe
 Positioning axis 	
 Number of positioning axes at motion control cycle of 4 ms (typical value) 	15
Number of positioning axes at motion control cycle of 8 ms (typical value)	30
Controller	
PID_Compact	Yes; Universal PID controller with integrated optimization
PID_3Step	Yes; PID controller with integrated optimization for valves
PID-Temp	Yes; PID controller with integrated optimization for temperature
Counting and measuring	
High-speed counter	Yes
Standards, approvals, certificates	
CE mark	Yes
CSA approval	Yes
cULus	Yes
FM approval	Yes
RCM (formerly C-TICK)	Yes
Ambient conditions	
Ambient temperature during operation	
• min.	-20 °C
• max.	Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules
horizontal installation, min.	-20 °C
horizontal installation, min.horizontal installation, max.	-20 °C 60 °C
•	
• horizontal installation, max.	60 °C
horizontal installation, max.vertical installation, min.	60 °C -20 °C
 horizontal installation, max. vertical installation, min. vertical installation, max. 	60 °C -20 °C
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Storage/transport, tested acc. to IEC 60068-2-27	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes
horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-7 tested according to IEC 60068-2-7 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system Configuration	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system Configuration Programming	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system Configuration Programming Programming language	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system Configuration Programming Programming language — LAD	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system Configuration Programming Programming language LAD FBD 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system Configuration Programming Programming language LAD FBD STL 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system Configuration Programming Programming language LAD FBD STL SCL 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system Configuration Programming Programming language LAD FBD STL 	60 °C -20 °C 50 °C; With max. 32 ET 200SP modules -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye

Know-how protection		
 User program protection/password protection 	Yes	
 Copy protection 	Yes	
Block protection	Yes	
Access protection		
 Protection level: Write protection 	Yes	
 Protection level: Read/write protection 	Yes	
 Protection level: Complete protection 	Yes	
Cycle time monitoring		
 lower limit 	adjustable minimum cycle time	
• upper limit	adjustable maximum cycle time	
Open Development interfaces		
 Size of ODK SO file, max. 	5.8 Mbyte	
Peripherals/Options		
SD card	Optionally for additional mass storage	
Dimensions		
Width	160 mm	
Height	117 mm	
Depth	75 mm	
Weights		
Weight, approx.	0.83 kg	
last modified:	3/2/2021 🗗	